

# Qualcomm® QCS6490 Ultra Small Size Embedded System

#### **KEY FEATURES**



#### Qualcomm

Qualcomm QCS6490 high-level platform



# **High Speed Memory Down**

LPDDR5x on board memory up to 8G



## **Multiple Expansions**

1 M.2 E key 2230, 1 M.2 B key 3052



#### Rich I/O

2 USB 3.1, 1 GbE LAN, 1 HDMI, 1 Audio Jack, 1 COM, 8 bit DIO/1 CAN FD



#### **AMR**

Target on AMR, box PC application







### **PANEL**



**Front View** 





**Rear View** 



**Left View** 



**Right View** 

# **SPECIFICATION**

PLATFORM	Platform	ARM
SYSTEM	Processor	QCS6490
		Qualcomm <sup>®</sup> Kryo™ 670, 8 cores, up to 2.7 GHz, 12 TOPS (INT8)
	Memory	LPDDR5x, 4/8GB
GRAPHICS	Display	1 x HDMI Type A, w/audio. 1080P support on Linux.
	Single Display	HDMI
STORAGE	External / Internal	Support UFS 3.1, default 128GB
		1 x uSD3.0 card
EXPANSION	Interface	1 x M.2 B key 3052 (USB 3.1/ Opt. USB 2.0)
		1 x M.2 E key 2230 (PCle x1)
		1 x Nano SIM slot
ETHERNET	Controller	AX88179A USB3 to GbE controller
LED	Indicators	1 x Status LED
1/0	Ethernet	1 x GbE (RJ-45)
	Serial	1 x RS-232
	USB	2 x USB 3.1 Gen1 Type A
	Display	1 x HDMI 1.4
	WiFi/LTE Antenna	3 x Antenna Holes
	DIO	8 bit DIO (Via Terminal block, Default 6 DIO)
INTERNAL I/O	USB	3 x USB 2.0 (UBJ1/2/4, 1x4P/1.25mm), UBJ4 could option to M.2 B key
		1 x USB Type C (Download only)
	Serial	2 x RS-232
POWER	Туре	5VDC
	Connector	2 pin Power Jack
	Consumption	<b>Typical:</b> QCS6490: 5V @ 0.6A (3.0Watt)
		Max.: QCS6490: 5V @ 1.45A (7.25Watt)
OS SUPPORT	Os Support	Ubuntu 20.04 (Linux Kernel 5.4.233)
MECHANISM	Construction	Sheet Metal
	Mounting	DIN Rail Mount
	Dimensions (W x H x D)	145mm x 34mm x 96mm
	Weight	TBD
ENVIRONMENT	Operating Temperature	-20~60°C
	Storage Temperature	-40 to 85°C
	Relative Humidity	10 to 95% RH (non-condensing)
STANDARDS AND CERTIFICATIONS	Shock	Operating: 3G, 11ms
		Non-Operating: 5G, 11ms
	Vibration	Operating: Random 5~500Hz, IEC68-2-64 (3G)
		<b>Non-Operating:</b> Sine 10~500Hz, IEC68-2-6 (3G)
	Certification	CE, FCC Class A, UKCA, RoHS